

ABSTRACT OF THE DISCLOSURE

The invention provides a circuit board that includes a flat core plate, a buildup layer having insulation layers and conductor layers alternately stacked on each other, and surface conductor layers provided on the buildup layer. The circuit board further includes deformation-interrupting sections extending through the insulation layers between the conductor layers as electric wires. The deformation-interrupting sections adjust the thermal expansion coefficient of the whole circuit board, and enhance the rigidity of the circuit board. The invention also provides a method for forming the circuit board.